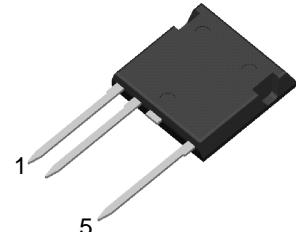
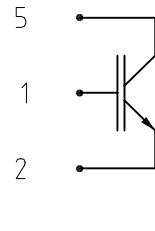


# High Voltage IGBT

in High Voltage  
ISOPLUS i4-PAC™

## IXLF 19N220A IXLF 19N250A

$I_{C25}$  = 32 A  
 $V_{CES}$  = 2200/2500 V  
 $V_{CE(sat)}$  = 3.2 V  
 $t_f$  = 50 ns



### IGBT

Symbol	Conditions	Maximum Ratings		
$V_{CES}$	$T_{VJ} = 25^\circ\text{C}$ to $150^\circ\text{C}$	IXLF 19N220A	2200	V
		IXLF 19N250A	2500	V
$V_{GES}$			$\pm 20$	V
$I_{C25}$	$T_c = 25^\circ\text{C}$	32	A	
$I_{C90}$	$T_c = 90^\circ\text{C}$	19	A	
$I_{CM}$	$V_{GE} = \pm 15$ V; $R_G = 47$ $\Omega$ ; $T_{VJ} = 125^\circ\text{C}$	70	A	
$V_{CEK}$	RBSOA, Clamped inductive load; $L = 100$ $\mu\text{H}$	1200	V	
$P_{tot}$	$T_c = 25^\circ\text{C}$	250	W	

Symbol	Conditions	Characteristic Values		
		( $T_{VJ} = 25^\circ\text{C}$ , unless otherwise specified)		
$V_{CE(sat)}$	$I_c = 19$ A; $V_{GE} = 15$ V; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	3.2 4.7	3.9 V	V
$V_{GE(th)}$	$I_c = 1$ mA; $V_{GE} = V_{CE}$	5	8	V
$I_{CES}$	$V_{CE} = V_{CES}$ ; $V_{GE} = 0$ V; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.2	0.15 mA mA	
$I_{GES}$	$V_{CE} = 0$ V; $V_{GE} = \pm 20$ V		500 nA	
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $E_{on}$ $E_{off}$	Inductive load, $T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 1500$ V; $I_c = 19$ A $V_{GE} = \pm 15$ V; $R_G = 47$ $\Omega$	200 100 600 50 11 3.6	ns ns ns ns mJ mJ	
$C_{ies}$	$V_{CE} = 25$ V; $V_{GE} = 0$ V; $f = 1$ MHz	2.2	nF	
$Q_{Gon}$	$V_{CE} = 800$ V; $V_{GE} = 15$ V; $I_c = 19$ A	130	nC	
$R_{thJC}$			0.5 K/W	

### Features

- High Voltage IGBT
  - substitute for high voltage MOSFETs with significantly lower voltage drop and comparable switching speed
  - substitute for high voltage thyristors with voltage control of turn on and turn off
  - substitute for electromechanical trigger and discharge relays
- ISOPLUS i4-PAC™ high voltage package
  - isolated back surface
  - enlarged creepage towards heatsink
  - enlarged creepage between high voltage pins
  - application friendly pinout
  - high reliability
  - industry standard outline

### Applications

- switched mode power supplies
- DC-DC converters
- resonant converters
- laser generators, x ray generators
- discharge circuits

**Component**

Symbol	Conditions	Maximum Ratings		
		-55...+150	-55...+125	°C
$T_{VJ}$				
$T_{stg}$				
$V_{ISOL}$	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$	2500	V-	
$F_c$	mounting force with clip	20...120	N	
Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
$d_s d_A$	C pin - E pin	7.0		mm
$d_s d_A$	pin - backside metal	5.5		mm
$R_{thCH}$	with heatsink compound	0.15		K/W
<b>Weight</b>		9		g

**Dimensions in mm (1 mm = 0.0394")**